Onsemi

<u>MOSFET</u> – Dual N-Channel, POWERTRENCH[®]

40 V, 12 A, 10 m Ω

FDMC8030

General Description

This device includes two 40 V N-Channel MOSFETs in a dual Power 33 (3 mm x 3 mm MLP) package. The package is enhanced for exceptional thermal performance.

Features

- Max $r_{DS(on)} = 10 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 12 \text{ A}$
- Max $r_{DS(on)} = 14 \text{ m}\Omega$ at $V_{GS} = 4.5 \text{ V}$, $I_D = 10 \text{ A}$
- Max $r_{DS(on)} = 28 \text{ m}\Omega$ at $V_{GS} = 3.2 \text{ V}$, $I_D = 4 \text{ A}$
- This Device is Pb-Free and is RoHS Compliant

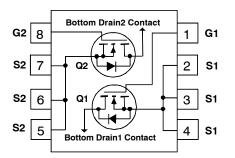
Applications

- Battery Protection
- Load Switching
- Point of Load

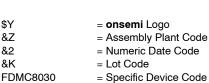
MOSFET MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Detingo	Units
Symbol	Parameter	Ratings	Units
Vds	Drain to Source Voltage	40	v V
Vgs	Gate to Source Voltage (Note 4)	±12	V
I _D	Drain Current - Continuous T _A = 25°C (Note 1a) - Pulsed	12 50	A
Eas	Single Pulse Avalanche Energy (Note 3)	21	mJ
P _D	Power Dissipation $T_c = 25^{\circ}C$	14	W
	Power Dissipation $T_A = 25^{\circ}C$ (Note 1a)	1.9	
Тј, Тѕтс	Operating and Storage Junction Temperature Range	–55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.







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ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet

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THERMAL CHARACTERISTICS

Symbol	Parameter	Rating	Units
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case	9.0	°C/W
$R_{\theta JA}$	R _{0JA} Thermal Resistance, Junction to Ambient (Note 1a)		
R _{θJA}	Thermal Resistance, Junction to Ambient (Note 1b)	155	

PACKAGE MARKING AND ORDERING INFORMATION

Device	Device Marking	Package	Shipping [†]
FDMC8030	FDMC8030	WDFN8 3x3, 0.65P, Power 33 (Pb–Free)	3000 units / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T₁ = 25°C unless otherwise noted)

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
OFF CHARA	L CTERISTICS				5	
BV _{DSS}	Drain to Source Breakdown Voltage	I_D = 250 μA, V _{GS} = 0 V	40	0v		V
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta \text{T}_{\text{J}}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25°C	E	19		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 32 V, V _{GS} = 0 V	Ś	2	1	μA
I _{GSS}	Gate to Source Leakage Current, Forward	V _{GS} = 12 V, V _{DS} = 0 V), _	100	nA
ON CHARAC	CTERISTICS	IDE ON	P,			
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \mu A$	1.0	1.5	2.8	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$H_D = 250 \mu$ A, referenced to 25° C		-5		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10$ V, $I_D = 12$ A		8	10	mΩ
	C Th	V _{GS} = 4.5 V, I _D = 10 A		10	14	
	NOCO	$V_{GS} = 3.2 \text{ V}, \text{ I}_{D} = 4 \text{ A}$		19	28	
	EISNO'EC	V _{GS} = 10 V, I _D = 12 A, T _J = 125°C		13	16	1
g fs	Forward Transconductance	V _{DD} = 5 V, I _D = 12 A		57		S
DYNAMIC C	HARACTERISTICS	·				
C _{iss}	Input Capacitance	V _{DS} = 20 V, V _{GS} = 0 V f = 1 MHz		1462	1975	pF
Coss	Output Capacitance			321	430	pF
C _{rss}	Reverse Transfer Capacitance			20	30	pF
Rg	Gate Resistance			0.9	2.5	Ω
SWITCHING	CHARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 20 V, I _D = 12 A V _{GS} = 10 V, R _{GEN} = 6 Ω		7	13	ns
t _r	Rise Time	$V_{GS} = 10$ V, $R_{GEN} = 6 \Omega$		3	10	ns
t _{d(off)}	Turn-Off Delay Time			19	33	ns
t _f	Fall Time			3	10	ns
Q _{g(TOT)}	Total Gate Charge	V_{GS} = 0 V to 10 V, V_{DD} = 20 V, I_{D} = 12 A		21	30	nC
	Total Gate Charge	V_{GS} = 0 V to 5 V, V_{DD} = 20 V, I_{D} = 12 A		12	17	nC
Q _{gs}	Gate to Source Charge	$V_{DD} = 20 V$		2.8		nC
Q _{gd}	Gate to Drain "Miller" Charge	I _D = 12 A		2.5		nC

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted) (continued)

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Unit	
DRAIN-SOURCE DIODE CHARACTERISTICS							
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 12 A$ (Note 2)		0.83	1.2	V	
t _{rr}	Reverse Recovery Time	I _F = 12 A, di/dt = 100 A/μs		25	40	ns	
Q _{rr}	Reverse Recovery Charge			9	18	nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

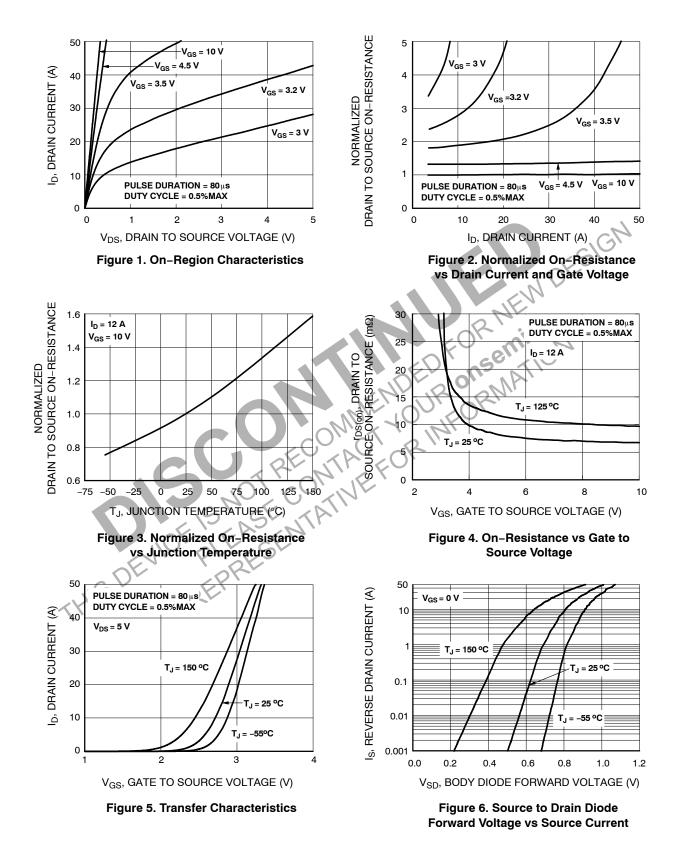
NOTES:

1. R_{0,JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0,JC} is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



TYPICAL CHARACTERISTICS

 $(T_J = 25^{\circ}C \text{ UNLESS OTHERWISE NOTED})$



TYPICAL CHARACTERISTICS (CONTINUED)

 $(T_J = 25^{\circ}C \text{ UNLESS OTHERWISE NOTED})$

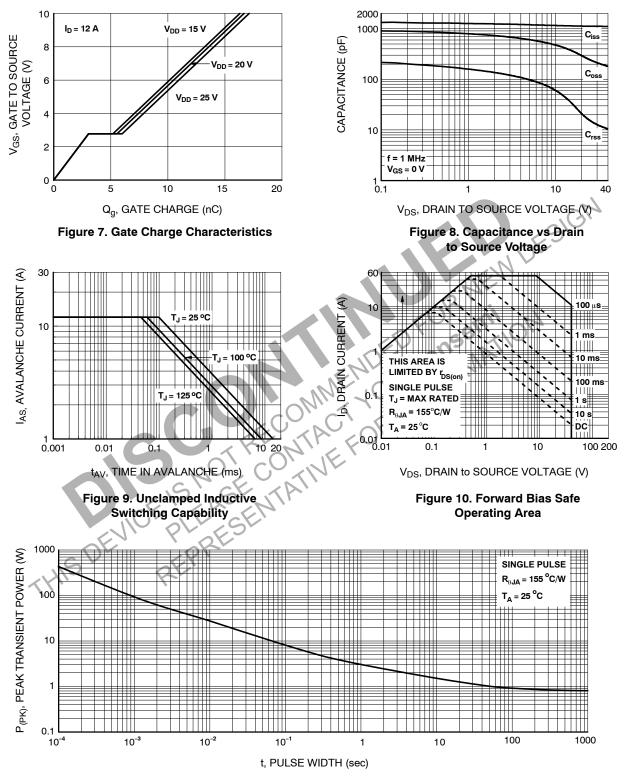
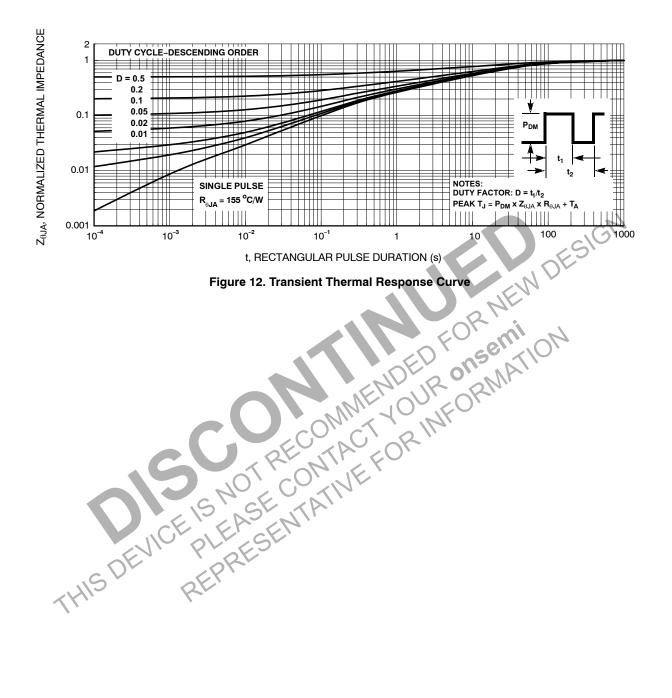


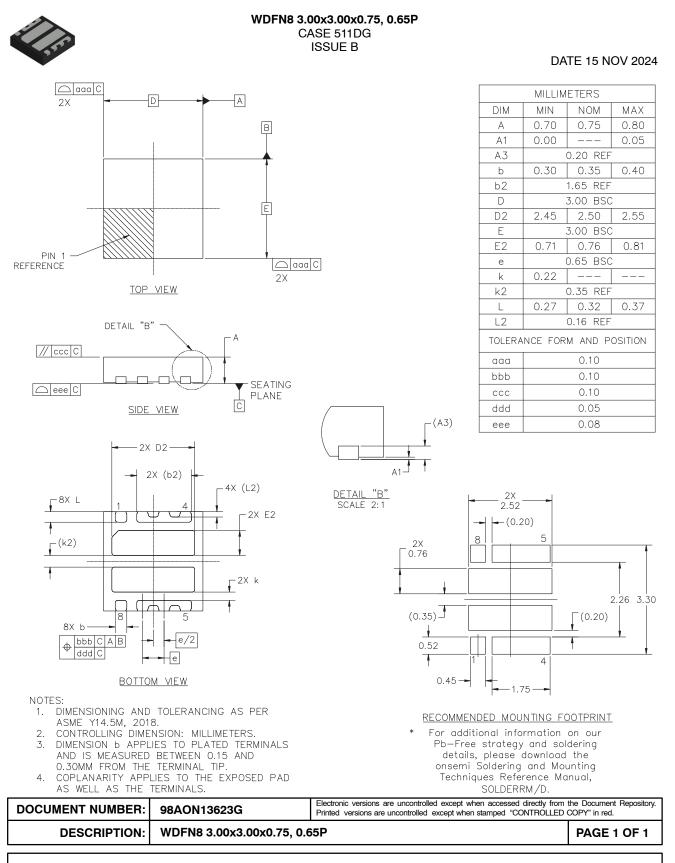
Figure 11. Single Pulse Maximum Power Dissipation





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